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This listing of claims will replace all prior versions, and listings, of claims in the application:

**LISTING OF CLAIMS:**

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Claim 1 (currently amended): A method for adjusting a frequency characteristic of an edge reflection type surface acoustic wave device, comprising the steps of:

determining ~~a~~the frequency characteristic of ~~an~~the edge reflection type surface acoustic wave device having a piezoelectric substrate, the edge reflection type surface acoustic wave device having a pair of edges of the piezoelectric substrate which define a predetermined distance therebetween; and

cutting the piezoelectric substrate at at least one of a pair of positions which define a distance that is shorter than the predetermined distance when a final frequency characteristic of the edge reflection type surface acoustic wave device is to be higher than ~~the~~an obtained frequency characteristic, and cutting the piezoelectric substrate at at least one of a pair of positions which define a distance that is longer than the predetermined distance when a final frequency characteristic of the edge reflection type surface acoustic wave device is to be lower than the obtained frequency characteristic.

Claim 2 (original): A method for adjusting a frequency characteristic of an edge reflection type surface acoustic wave device according to claim 1, wherein the positions at which the piezoelectric substrate is cut in the piezoelectric substrate cutting step is shifted from positions of the edges which define the predetermined distance in the frequency characteristic obtaining step by about  $\lambda/8$  or less, where the  $\lambda$  is wavelength of a shear horizontal type surface wave to be excited in the edge reflection type surface acoustic wave device.

Claim 3 (original): A method for adjusting a frequency characteristic of an edge reflection type surface acoustic wave device according to claim 1, wherein the positions

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at which the piezoelectric substrate is cut in the piezoelectric substrate cutting step is shifted from positions of the edges which define the predetermined distance in the frequency characteristic obtaining step by about  $\lambda/16$  or less, where the  $\lambda$  is wavelength of a shear horizontal type surface wave to be excited in the edge reflection type surface acoustic wave device.

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Claim 4 (original): A method for adjusting a frequency characteristic of an edge reflection type surface acoustic wave device according to claim 1, wherein the edge reflection type surface acoustic wave device comprises a single electrode type interdigital transducer.

Claim 5 (original): A method for adjusting a frequency characteristic of an edge reflection type surface acoustic wave device according to claim 4, wherein the positions of the edges which define the predetermined distance are located at approximate centers of electrodes.

Claim 6 (original): A method for adjusting a frequency characteristic of an edge reflection type surface acoustic wave device according to claim 1, wherein the edge reflection type surface acoustic wave device comprises a double electrode type interdigital transducer.

Claim 7 (currently amended): A method for adjusting a frequency characteristic of an edge reflection type surface acoustic wave device according to claim 6, wherein each of the positions of the edges which define the predetermined distance is located at an approximate center of a pair of electrode fingers constituting a double electrode.

Claim 8-15 (canceled)